



**Alfa-MOS
Technology**

**AFN2330
90V N-Channel
Enhancement Mode MOSFET**

General Description

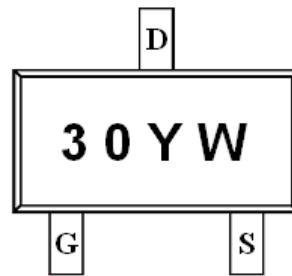
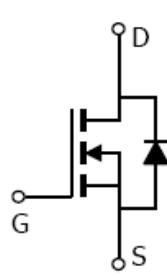
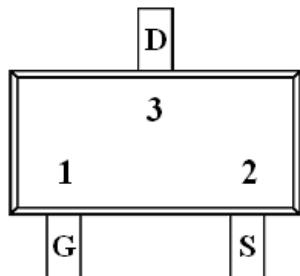
AFN2330, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 90V/2.8A, $R_{DS(ON)}=190m\Omega$ @ $V_{GS}=10V$
- 90V/2.0A, $R_{DS(ON)}=200m\Omega$ @ $V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

Pin Description (SOT-23-3L)



Application

- DC/DC Converters
- Load Switch
- LED Backlighting in LCD TVs

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN2330S23RG	30YW	SOT-23-3L	Tape & Reel	3000 EA

- ※ 30 parts code
- ※ Y year code (0 ~ 9)
- ※ W week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFN2330S23RG : 7" Tape & Reel ; Pb- Free ; Halogen- Free



Absolute Maximum Ratings

($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V_{DSS}	90	V
Gate –Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current($T_J=150^\circ\text{C}$)	I_D	2.8	A
$T_c=70^\circ\text{C}$		2.0	
Pulsed Drain Current	I_{DM}	6	A
Continuous Source Current(Diode Conduction)	I_S	1.6	A
Power Dissipation	P_D	1.25	W
$T_A=70^\circ\text{C}$		0.8	
Operating Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	R_{eJA}	120	$^\circ\text{C}/\text{W}$

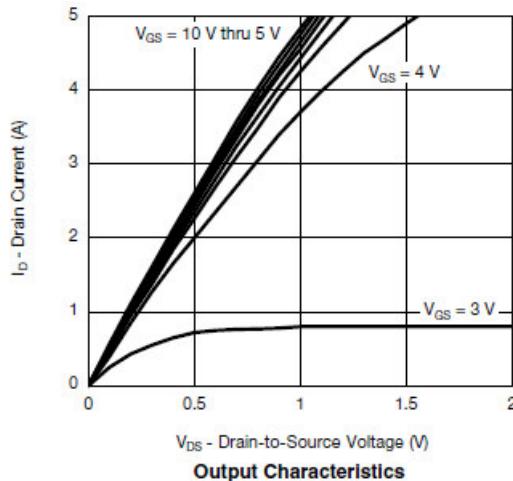
Electrical Characteristics

($T_A=25^\circ\text{C}$ Unless otherwise noted)

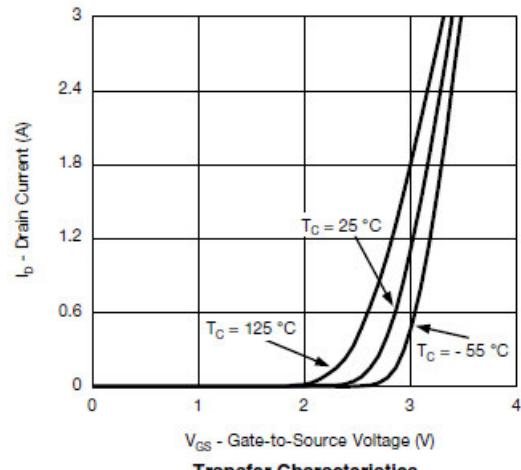
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	90			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		2.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=72\text{V}, V_{GS}=0\text{V}$			1	uA
		$V_{DS}=72\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			10	
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS}\geq 5\text{V}, V_{GS}=4.5\text{V}$	6			A
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=10\text{V}, I_D=2.8\text{A}$		170	190	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=2.0\text{A}$		180	200	
Forward Transconductance	g_{FS}	$V_{DS}=20\text{V}, I_D=1.5\text{A}$		2		S
Diode Forward Voltage	V_{SD}	$I_S=1.3\text{A}, V_{GS}=0\text{V}$		0.85	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=50\text{V}, V_{GS}=4.5\text{V}$ $I_D=1.6\text{A}$		2.8	5.8	nC
Gate-Source Charge	Q_{gs}			0.75		
Gate-Drain Charge	Q_{gd}			1.4		
Input Capacitance	C_{iss}	$V_{DS}=50\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		200		pF
Output Capacitance	C_{oss}			22		
Reverse Transfer Capacitance	C_{rss}			13		
Turn-On Time	$t_{d(\text{on})}$	$V_{DD}=50\text{V}, R_L=39\Omega$ $I_D=1.3\text{A}, V_{GEN}=4.5\text{V}$		25	50	ns
	t_r			20	50	
Turn-Off Time	$t_{d(\text{off})}$			15	30	
	t_f			10	25	



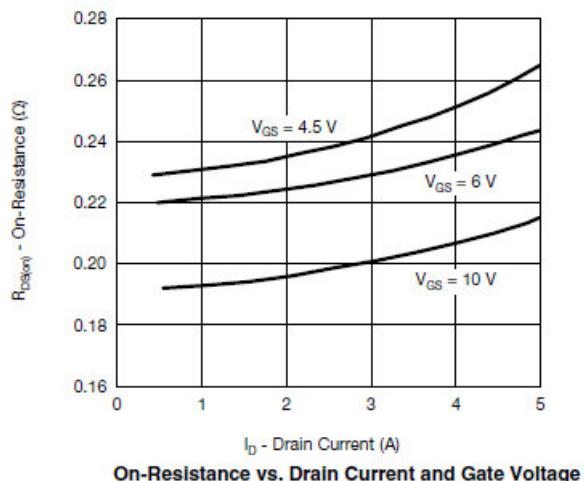
Typical Characteristics



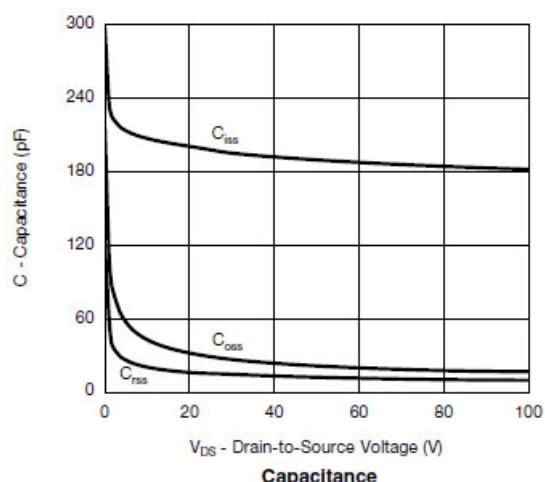
Output Characteristics



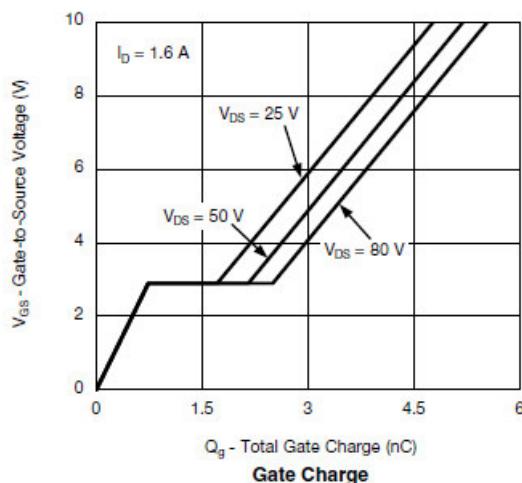
Transfer Characteristics



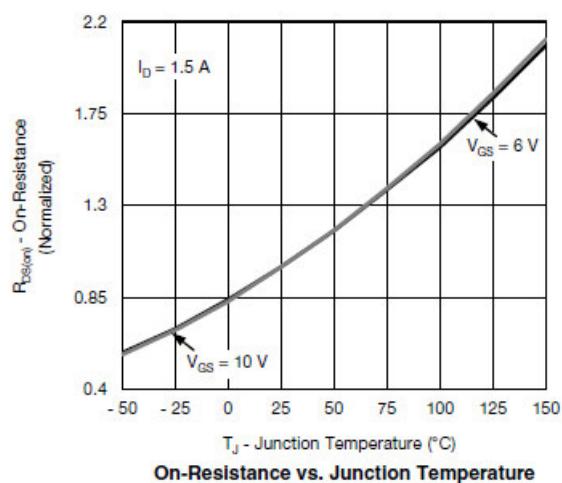
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



Gate Charge



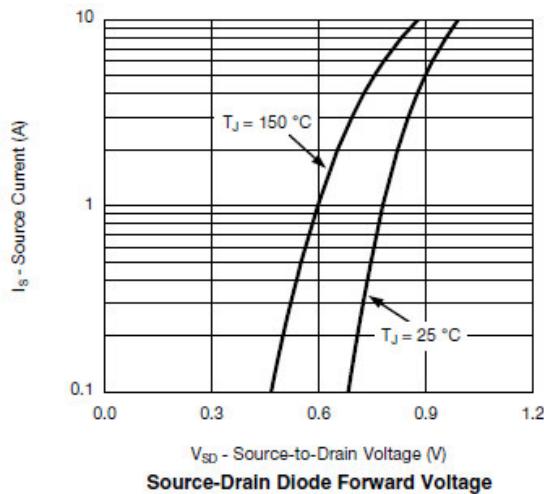
On-Resistance vs. Junction Temperature



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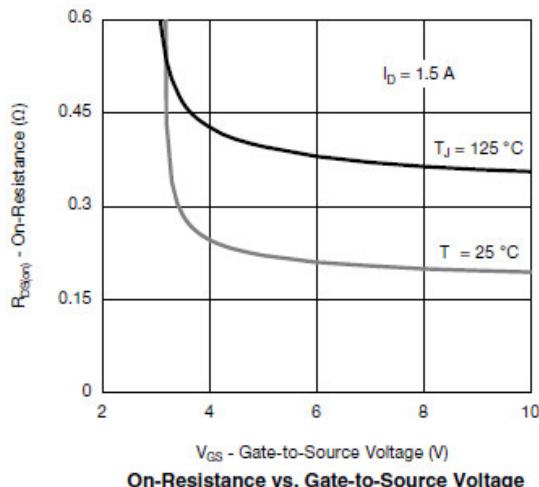
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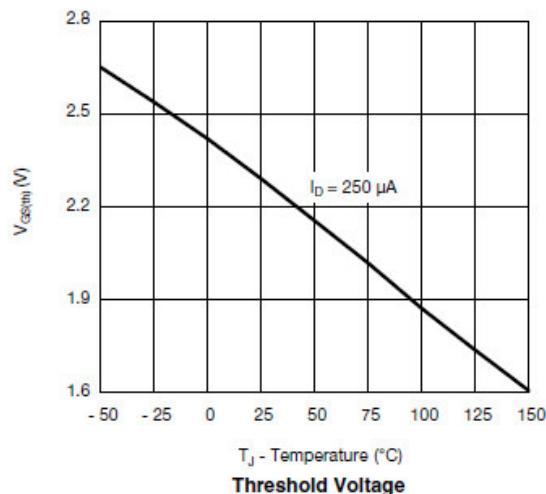
V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage



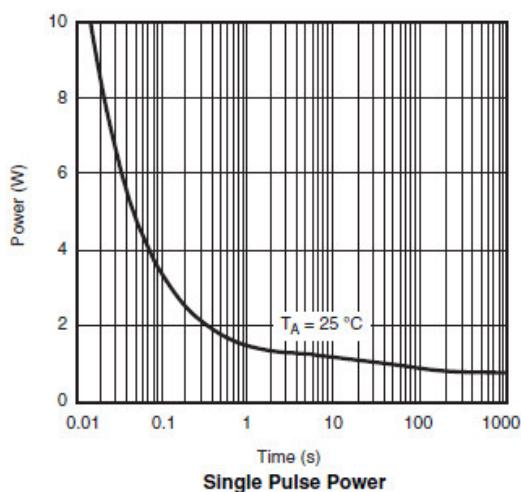
V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



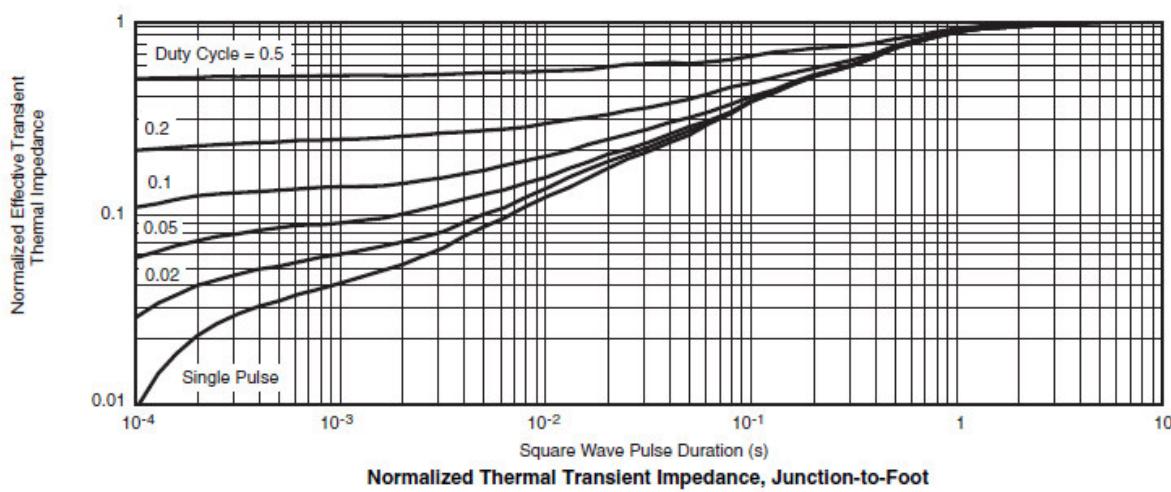
T_J - Temperature ($^\circ C$)

Threshold Voltage



Time (s)

Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Foot

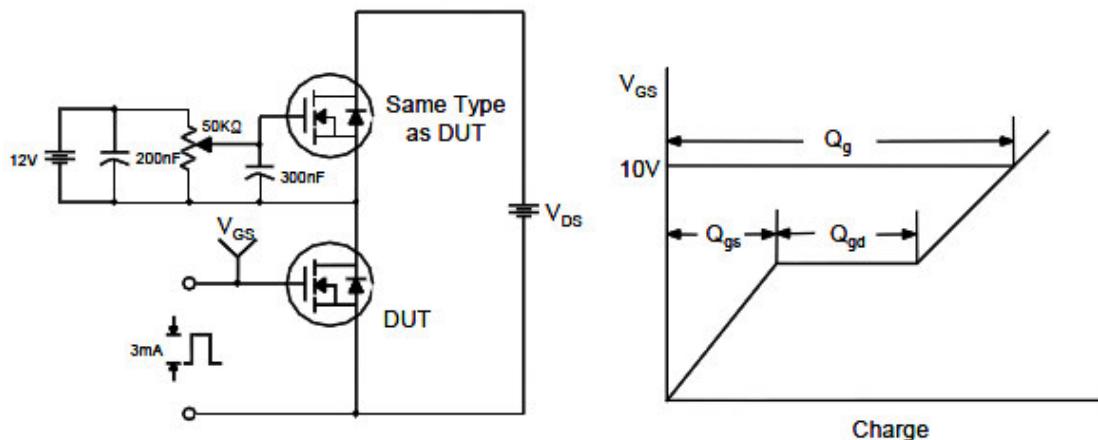


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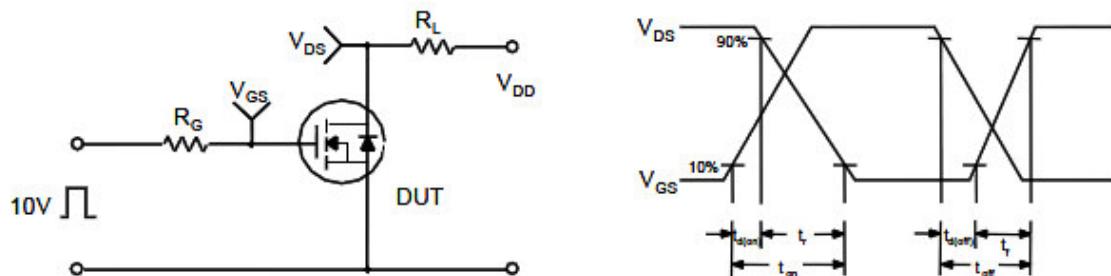
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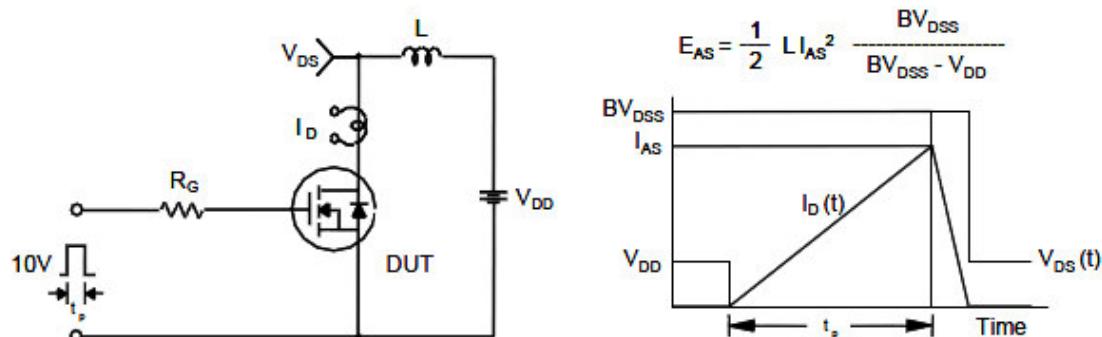
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

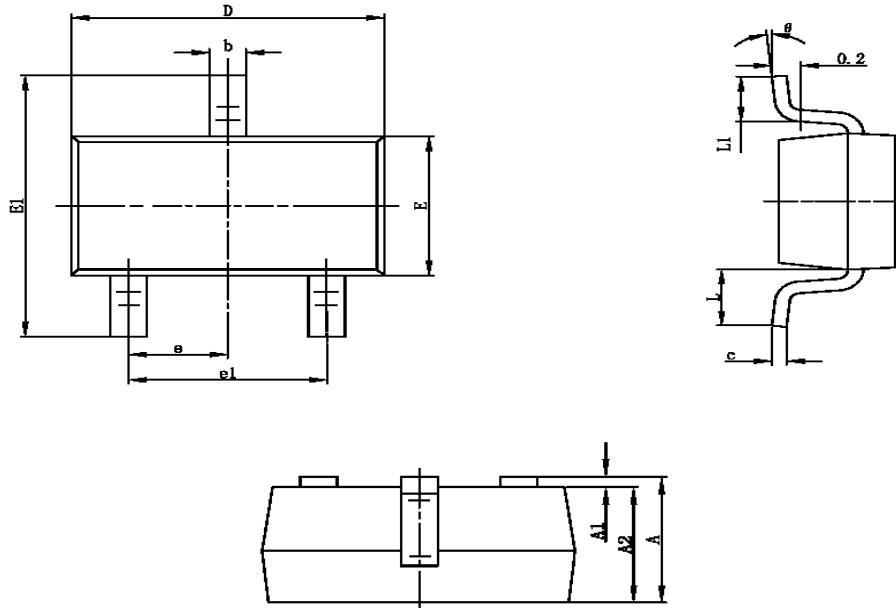




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Package Information (SOT-23-3L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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